KEMET Part Number: CBR06C209B5GAC



CBR-SMD RF C0G, Ceramic, 2 pF, +/-0.1 pF, 50 VDC, C0G, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0603



| Dimensions | | |
|------------|-----------------|--|
| Chip Size | 0603 | |
| L | 1.6mm +/-0.1mm | |
| W | 0.8mm +/-0.1mm | |
| Т | 0.8mm +/-0.07mm | |
| В | 0.4mm +/-0.15mm | |

| Packaging Specifications | | |
|--------------------------|--------------------------|--|
| Packaging: | T&R, 180mm, Plastic Tape | |
| Packaging Quantity: | 4000 | |

| General Information | |
|---------------------|---|
| Series: | CBR-SMD RF C0G |
| Style: | SMD Chip |
| Description: | SMD, Fixed, RF, Ultra High Q, Low ESR, Class I |
| Features: | Ultra High Q, Low ESR, Class I |
| RoHS: | Yes |
| Termination: | Tin |
| Marking: | No |
| AEC-Q200: | No |
| Notes: | Solder Wave or Solder Reflow. |
| Shelf Life: | 78 Weeks |
| MSL: | 1 |

| Specifications | |
|-------------------------------------|---------------------|
| Capacitance: | 2 pF |
| Capacitance Tolerance: | +/-0.1 pF |
| Voltage DC: | 50 VDC |
| Dielectric Withstanding Voltage: | 125 VDC |
| Temperature Range: | -55/+125°C |
| Temperature Coefficient: | COG |
| Dissipation Factor: | 0.227% |
| Aging Rate: | 0% Loss/Decade Hour |
| Insulation Resistance: | 10 GOhms |
| Quality Factor: | 440 |

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